



Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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Supplier Information

Company Name * STMicroelectronics	Company Unique ID	Unique ID Authority	Response Date * N/A	Response Document ID				
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *	Duplicate Contact -> Authorized Representative				
Authorized Representative * ANTONINO CONTRAFATTO	Title - Representative IPD MD CHAMPION	Phone - Representative * N/A	Email - Representative * N/A	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	L6480H	A5)S*UA53BB5	2012-07-16	A	ZY1A	123.174	mg	Each
Alternate Recommendation	PACKAGE:)S HTSSOP38 BOD			Alternate Item Comments	ECOPACK2/ROHS BSA REF. CD00332303			

Manufacturing Process Information

Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles
Tin (Sn)	CU Alloy	3	260 C	30 seconds	3

Comments

Disclaimer: While STMicroelectronics has endeavored to provide information which is accurate and up to date, this document and its contents are provided on a strict 'as is' and

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RoHS Material Composition Declaration

Declaration Type *

Simplified

RoHS Directive 2002/95/EC **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

RoHS Declaration * 1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance * Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Declaration Signature

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name		Homogeneous Material		Weight	Unit of Measure	Level		Substance Category	Substance		CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
+I	-I	+M	-M			+C	-C		+S	-S					-	+	
		A5)S*UA53BB5		5.477	mg			Supplier	Silicon Die	Silicon (Si)	7440-21-3		5.377	mg			981,74
								Supplier	Die Metallization	Aluminium (Al)	7429-90-5		0.001	mg			183
										Copper (Cu)	7440-50-8		0.003	mg			548
										Titanium (Ti)	7440-32-6		0.001	mg			183
										Chromium (Cr)	7440-47-3		0.004	mg			730
										Gold (Au)	7440-57-5		0.011	mg			2,008
										Nickel (Ni)	7440-02-0		0.032	mg			5,843
										Vanadium (V)	7440-62-2		0.002	mg			365
								Supplier	Die Coating	Gamma-butyrolactone	96-48-0		0.031	mg			5,660
										Polyhydroxyamide	55295-98-2		0.014	mg			2,556
										Alcoxysilane	Proprietary		0.001	mg			183
		LEADFRAME		57.185	mg			Supplier	Alloy	Copper (Cu)	7440-50-8		55.011	mg			961,98
										Nickel (Ni)	7440-02-0		1.716	mg			30,008
										Silicon (Si)	7440-21-3		0.372	mg			6,505
										Magnesium (Mg)	7439-95-4		0.086	mg			1,504
		LEADFRAME CO		1.259	mg			Supplier	Leadframe Coating	Silver (Ag)	7440-22-4		1.259	mg			1,000,0
		DIE ATTACH		1.248	mg			Supplier	Glue	Epoxy Resin A	Proprietary		0.087	mg			69,712
										Epoxy Resin B	Proprietary		0.05	mg			40,064
										Silver (Ag)	7440-22-4		0.961	mg			770,03
										Lactone	96-48-0		0.05	mg			40,064
										Polyoxypropylenediam	9046-10-0		0.05	mg			40,064
										2,6 Diglycidyl phenyl al	Proprietary		0.05	mg			40,064
		BONDING WIRE		0.749	mg			Supplier	Bonding Wire	Gold (Au)	7440-57-5		0.749	mg			1,000,0

+M	-M	ENCAPSULATIO	53.81	mg	+C	-C	Supplier	Molding Compound	+S	-S	Multi-aromatic resin	Proprietary		4.843	mg			90,002
									+S	-S	Silica, vitreous	60676-86-0		45.2	mg			839,99
									+S	-S	Phenol Resin	9003-35-4		3.498	mg			65,007
									+S	-S	Carbon Black	1333-86-4		0.269	mg			4,999
+M	-M	FINISHING	3.446	mg	+C	-C	Supplier	Connection Coating	+S	-S	Tin (Sn)	7440-31-5		3.446	mg			1,000,0